

UNISONIC TECHNOLOGIES CO., LTD

9N95 Power MOSFET

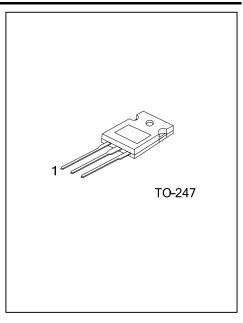
9A, 950V **N-CHANNEL POWER MOSFET**

DESCRIPTION

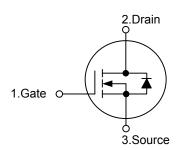
The UTC 9N95 uses UTC's advanced proprietary, planar stripe, DMOS technology to provide excellent R_{DS(ON)}, low gate charge and operation with low gate voltages. This device is suitable for use as a load switch or in PWM applications.

FEATURES

- * $R_{DS(ON)} \le 1.4\Omega$ @ V_{GS} =10V, I_D =4.5A
- * Fast Switching Capability
- * Avalanche Energy Specified
- * Improved dv/dt Capability, High Ruggedness



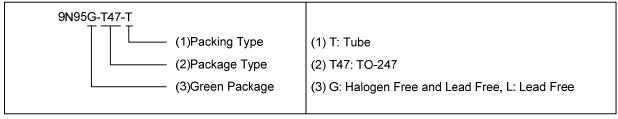
SYMBOL



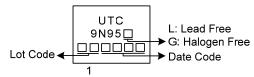
ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
9N95L-T47-T	9N95G-T47-T	TO-247	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain



MARKING



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■ ABSOLUTE MAXIMUM RATING (T_C =25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	950	V	
Gate-Source Voltage		V_{GSS}	±30	V	
Continuous Drain Current (T _C = 25°C)		I _D	9.0	Α	
Pulsed Drain Current (Note 2)		I _{DM}	36	Α	
Avalanche Current (Note 2)		I _{AR}	9.0	Α	
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	900	mJ	
	Repetitive(Note 2)	E _{AR}	28	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.0	V/ns	
Power Dissipation			160	W	
Linear Derating Factor		P_{D}	4.00	\A\\\\	
above T _C = 25°C			1.28	W/°C	
Junction Temperature		T_J	+150	°C	
Storage Temperature		T _{STG}	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 21mH, I_{AS} = 9.0A, V_{DD} = 50V, R_{G} = 25 $\Omega,$ Starting T_{J} = 25°C
- 4. $I_{SD} \le 9.0A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25$ °C

■ THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	50	°C/W	
Junction to Case	$\theta_{ m JC}$	0.78	°C/W	

■ **ELECTRICAL CHARACTERISTICS** (T_J =25°C, unless otherwise specified)

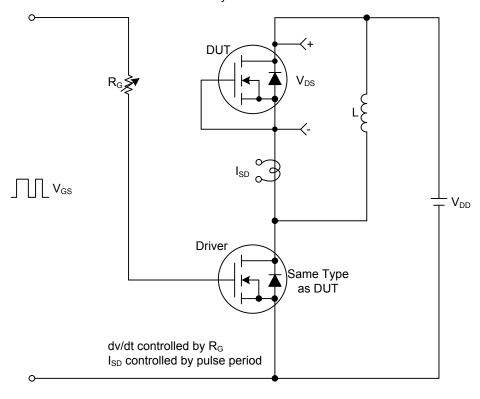
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu A$	950			V	
Drain-Source Leakage Current		I _{DSS}	$V_{DS} = 950 \text{ V}, V_{GS} = 0 \text{ V}$			10	μΑ	
Gate-Body Leakage Current	Forward	I_{GSSF}	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA	
	Reverse	I_{GSSR}	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA	
Breakdown Voltage Temperature Coefficient		$\triangle BV_{DSS}/\triangle T_J$	I _D =250μA, Referenced to 25°C		0.99		V/°C	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	3.0		5.0	V	
Static Drain-Source On-Resistance		R _{DS(ON)}	$V_{GS} = 10V, I_D = 4.5A$		1.05	1.4	Ω	
DYNAMIC PARAMETERS			,					
Input Capacitance		C _{ISS}	$-V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$		2100	2730	pF	
Output Capacitance		Coss	f = 1.0 MHz		175	230	pF	
Reverse Transfer Capacitance		C_{RSS}	1 - 1.0 WH12		14	18	pF	
SWITCHING CHARACTERIS	TICS							
Total Gate Charge		Q_G	V _{DS} = 760V, I _D = 11.0A, V _{GS} = 10 V (Note 1,2)		45	58	nC	
Gate-Source Charge		Q_GS			13		nC	
Gate-Drain Charge		Q_GD	V GS = 10 V (NOIC 1,2)		18		nC	
Turn-On Delay Time		$t_{D(ON)}$	V _{DD} = 475V, I _D =11.0 A,		50	110	ns	
Turn-On Rise Time		t _R	$R_G = 25\Omega$ (Note 1, 2)		120	250	ns	
Turn-Off Delay Time		t _{D(OFF)}	11.G - 2022 (140tC 1, 2)		100	210	ns	
Turn-Off Fall Time		t_{F}			75	160	ns	
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS								
Maximum Continuous Drain-Source Diode Forward Current		Is				9.0	Α	
						9.0	^	
Maximum Pulsed Drain-Source Diode Forward Current		Ізм				36	Α	
						30	^	
Drain-Source Diode Forward Voltage		V_{SD}	$V_{GS} = 0 \text{ V}, I_{S} = 9.0 \text{ A}$			1.4	V	
Reverse Recovery Time		t _{rr}	$V_{GS} = 0 \text{ V}, I_{S} = 9.0 \text{ A},$		550		ns	
Reverse Recovery Charge		Q_{rr}	d _{IF} / dt =100 A/μs (Note 1)		6.5		μC	

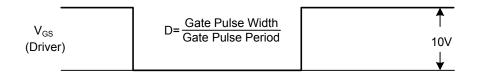
Notes: 1. Pulse Test : Pulse width≤300µs, Duty cycle≤2%.

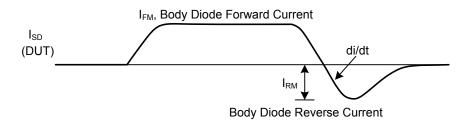
^{2.} Essentially independent of operating temperature.

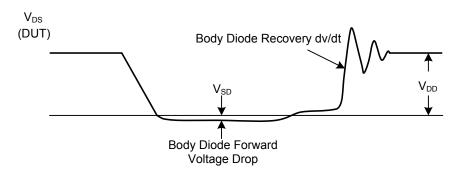
■ TEST CIRCUITS AND WAVEFORMS

Peak Diode Recovery dv/dt Test Circuit & Waveforms

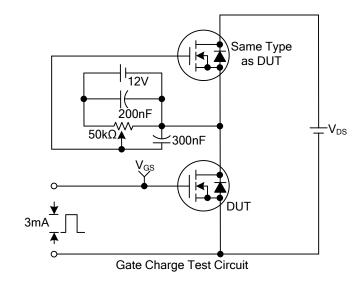


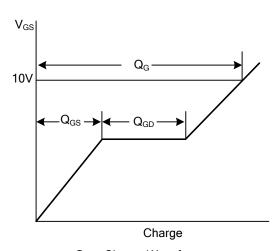




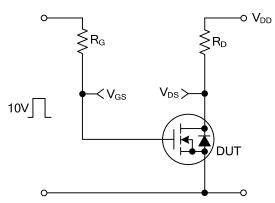


■ TEST CIRCUITS AND WAVEFORMS

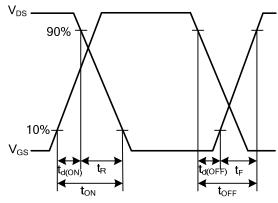




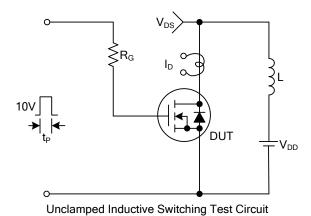
Gate Charge Waveforms

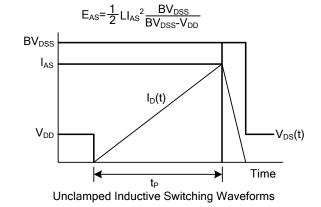


Resistive Switching Test Circuit



Resistive Switching Waveforms



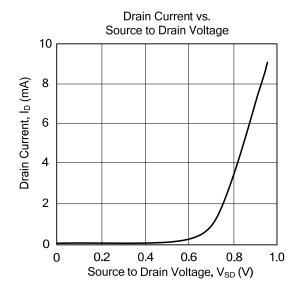


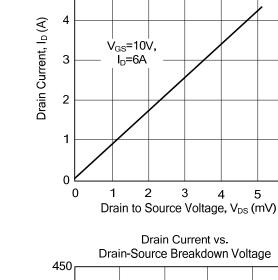
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Drain-Source

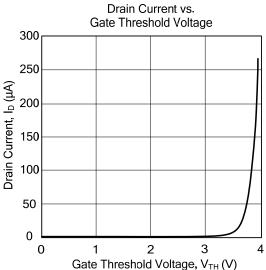
On-State Resistance Characteristics

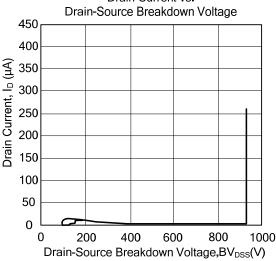
■ TYPICAL CHARACTERISTICS





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